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(54) ELECTRONIC DEVICE

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(57)ABSTRACT

An electronic device includes a first substrate having a first surface and a first side-surface adjacent to the first surface, a first electronic element and a second electronic element disposed on the first surface of the first substrate, a first conductive wire and a second conductive wire disposed on the first surface, and a first side conductive wire and a second side conductive wire disposed on the first side-surface. The first conductive wire is electrically connected to the first electronic element, and the second conductive wire is electrically connected to the second electronic element. The first side conductive wire is electrically connected to the first conductive wire, the second side conductive wire is electrically connected to the second conductive wire, and a width of the first side conductive wire along a direction is different from a width of the second side conductive wire along the direction.

